

TUSB2046B Schematic Checklist

Malik Barton

ABSTRACT

TUSB2046B is a USB hub device that provides one upstream port and four downstream ports in compliance with the Universal Serial Bus (USB) specification as a full-speed hub. This schematic checklist provides a brief explanation of each device pin and the recommended configuration of the device pin for default operation. Use this information to check the connectivity for each TUSB2046B on a system schematic.

This document is intended to aid design at the system level for general applications but should not be the only resource used. In addition to this list, customers are advised to use the information in the TUSB2046B datasheet, TUSB2046B EVM User's Guide and associated documents to gain a full understanding of device functionality.

NOTE: TUSB2046B has many configurations, this schematic checklist will cover a USB Hub that is configured over I2C with external EEPROM with downstream power switching and overcurrent reporting.

Trademarks

All trademarks are the property of their respective owners.

1 TUSB2046B Schematic Checklist

Table 1. Schematic Checklist

Pin Name	Pin Number(s)	Pin Description	Recommendation
Power Pins			
VCC33	3, 25	3.3 V Positive Power Supply	0.1 uF and 10 uF decoupling capacitors on each VCC pin to GND.
GND	7, 28	Ground	Connected to Ground.
Configuration Pins			
BUSPWR	8	Controls Downstream Facing Ports power source and indicator to USB Host.	Connect 2KΩ pull down to GND for Self-powered mode. This indicates to host downstream ports are powered by external source.
EXTMEMz	26	External EEPROM Indicator.	EXTMEMz = 0, Connect to 3.3V if no external EEPROM is used. EXTMEMz != 0, Connect to GND to use external EEPROM.
EECLK	5	EEPROM Serial Clock	EXTMEMz = 0, Leave pin floating (unconnected). EXTMEMz != 0, Connect to 3-state serial clock output from external EEPROM.
EEDATA/GANGED	6	EEPROM Serial Data/ Power-management indicator.	EXTMEMz = 0, Connect to data line of external EEPROM. EXTMEMz !=0, Connect to GND for per-port power overcurrent detection on downstream ports.
SUSPND	32	Indicates suspend mode on downstream facing ports	Leave unconnected or connect to external power down logic. For normal operation, SUSPND is low. For suspend mode, SUSPND is high.

Table 1. Schematic Checklist (continued)

Pin Name	Pin Number(s)	Pin Description	Recommendation
TSTMODE	31	Determines 6-MHz or 48-MHz clock mode of TUSB2046B	Connect pin to GND for 6-MHz operation.
TSTPLL/48MCLK	27	Test pin for 6 MHz internal clock or Input pin for 48 MHz external clock.	Connect pin to GND for 6-MHz operation.
XTAL1	30	Crystal clock input.	Using a 6-MHz crystal with 50% duty cycle, Connect the Crystal output to XTAL1. See section 8.3.2 of datasheet for more information.
XTAL2	29	Crystal clock output	Using a 6-MHz crystal with 50% duty cycle, Connect the Crystal input to XTAL2. See section 8.3.2 of datasheet for more information. Leave pin floating when using an oscillator.
RESETz	4	Device active low reset.	Connect to Power-On Reset Circuitry. Must be asserted at power up. When RESET is asserted, all logic is initialized. Generally, a reset with a pulse width between 100 μ s and 1 ms is recommended after 3.3-V VCC reaches its 90%. Clock signal has to be active during the last 60 μ s of the reset window.
Upstream Facing Port			
DM0	2	Upstream or Root Differential Pair for USB Full Speed Communication.	Connect DM0 and DP0 to D- and D+, respectively, to USB connector on upstream facing hub to USB host.
DP0	1		
Downstream Facing Port [4:1]			
DM[4:1]	11	Downstream Differential Pair for USB Full Speed Port [4:1].	Connect DM1 and DP1 to D- and D+, respectively, to USB connector on downstream facing hub to USB device.
DP[4:1]	12		
OVRCUR[4:1]	10	Input for overcurrent event status on downstream port [4:1].	Connect to overcurrent indicator (FTL pin) on power switch for downstream port [4:1] to allow host control of downstream port power.
PWRON[4:1]	9	Port [4:1] power control signals. Push-Pull output.	Connect to power switch EN pin to allow host control of downstream port power and protection in overcurrent event.
Notes: Routing through ESD or common mode choke before receptacle is allowed and recommended. Common mode chokes placed as close as possible to the USB connectors. Verify the pinout of the USB connectors. Verify pin-out of TUSB2046B matches datasheet. Always refer to the datasheet of this device for complete descriptions of each pin. For USB compliant applications overcurrent events on downstream ports must be reported to the USB host.			

2 References

- [4-Port Hub for the Universal Serial Bus With Optional Serial EEPROM Interface, Datasheet](#)

IMPORTANT NOTICE FOR TI DESIGN INFORMATION AND RESOURCES

Texas Instruments Incorporated ("TI") technical, application or other design advice, services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using any particular TI Resource in any way, you (individually or, if you are acting on behalf of a company, your company) agree to use it solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources.

You understand and agree that you remain responsible for using your independent analysis, evaluation and judgment in designing your applications and that you have full and exclusive responsibility to assure the safety of your applications and compliance of your applications (and of all TI products used in or for your applications) with all applicable regulations, laws and other applicable requirements. You represent that, with respect to your applications, you have all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. You agree that prior to using or distributing any applications that include TI products, you will thoroughly test such applications and the functionality of such TI products as used in such applications. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

You are authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING TI RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY YOU AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

You agree to fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of your non-compliance with the terms and provisions of this Notice.

This Notice applies to TI Resources. Additional terms apply to the use and purchase of certain types of materials, TI products and services. These include; without limitation, TI's standard terms for semiconductor products (<http://www.ti.com/sc/docs/stdterms.htm>), [evaluation modules](#), and [samples](http://www.ti.com/sc/docs/sampterm.htm) (<http://www.ti.com/sc/docs/sampterm.htm>).

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2018, Texas Instruments Incorporated